HEF4555B 1-of-4 decoder/demultiplexer Rev. 5 — 18 November 2011

**Product data sheet** 

### 1. General description

The HEF4555B contains two 1-of-4 decoders/demultiplexers. Each has two address inputs (nA0 and nA1, an active LOW enable input ( $n\overline{E}$ ) and four mutually exclusive outputs which are active HIGH (nY0 to nY3). When used as a decoder,  $n\overline{E}$  when HIGH, forces nY0 to nY3 LOW. When used as a demultiplexer, the appropriate output is selected by the information on nA0 and nA1 with  $n\overline{E}$  as data input. All unselected outputs are LOW.

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$  (usually ground). Unused inputs must be connected to  $V_{DD}$ ,  $V_{SS}$ , or another input.

### 2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from –40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

## 3. Applications

- Code conversion
- Address decoding
- Demultiplexing: when using the enable input as data input

# 4. Ordering information

#### Table 1.Ordering information

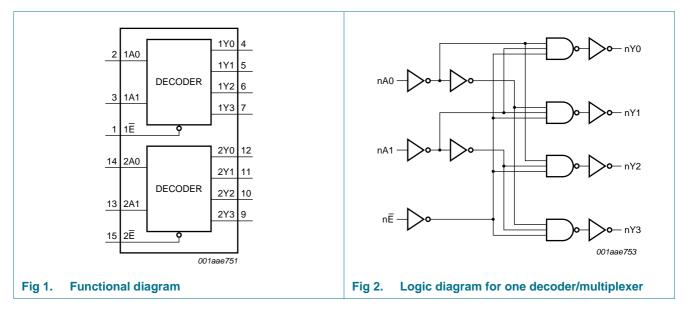
All types operate from -40 °C to +85 °C.

Type number	Package						
	Name	Description	Version				
HEF4555BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4				
HEF4555BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1				



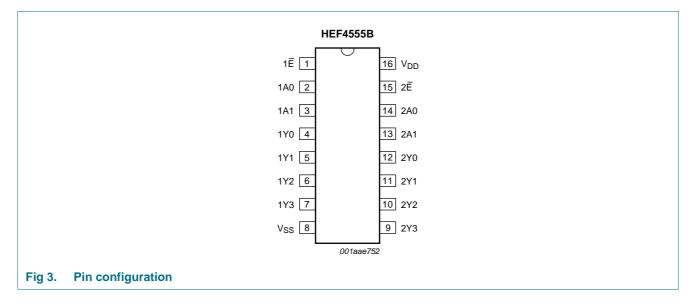
1-of-4 decoder/demultiplexer

# 5. Functional diagram



# 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Pin	Description
2, 3, 14, 13	address input
1, 15	enable input (active LOW
4, 5, 6, 7, 12, 11, 10, 9	output (active HIGH)
16	supply voltage
8	ground (GND)
	2, 3, 14, 13 1, 15 4, 5, 6, 7, 12, 11, 10, 9 16

# 7. Functional description

#### Table 3. Function selection<sup>[1]</sup>

Inputs			Outputs	Outputs			
nE	nA0	nA1	nY0	nY1	nY2	nY3	
L	L	L	Н	L	L	L	
L	Н	L	L	Н	L	L	
L	L	Н	L	L	Н	L	
L	Н	Н	L	L	L	Н	
Н	Х	Х	L	L	L	L	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

# 8. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V <sub>DD</sub> + 0.5	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_{\rm O} < -0.5$ V or $V_{\rm O} > V_{\rm DD}$ + 0.5 V	-	±10	mA
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C
P <sub>tot</sub>	total power dissipation	DIP16 package	<u>[1]</u> -	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP16 package:  $P_{tot}$  derates linearly with 12 mW/K above 70 °C.

[2] For SO16 package:  $P_{tot}$  derates linearly with 8 mW/K above 70  $^\circ C.$ 

# 9. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DD</sub>	supply voltage		3	-	15	V
VI	input voltage		0	-	$V_{DD}$	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$ input transition r	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V <sub>DD</sub> = 10 V	-	-	0.5	μs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V

# **10. Static characteristics**

#### Table 6. Static characteristics

 $V_{SS} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	= 25 °C	T <sub>amb</sub> =	85 °C	Unit
				Min	Max	Min	Max	Min	Max	
/IH HIGH-level input voltage		I <sub>O</sub>   < 1 μA	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$ I_0  < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V <sub>OH</sub>	HIGH-level output voltage	$ I_0  < 1 \ \mu A;$	5 V	4.95	-	4.95	-	4.95	-	V
		$V_{I} = V_{SS} \text{ or } V_{DD}$	10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V <sub>OL</sub>	CoL LOW-level output voltage	$ I_0  < 1 \ \mu A;$	5 V	-	0.05	-	0.05	-	0.05	V
	$V_{I} = V_{SS} \text{ or } V_{DD}$	10 V	-	0.05	-	0.05	-	0.05	V	
			15 V	-	0.05	-	0.05	-	0.05	V
loн	HIGH-level output current	$V_0 = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		V <sub>O</sub> = 4.6 V	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		V <sub>O</sub> = 9.5 V	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V <sub>O</sub> = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mA
I <sub>OL</sub>	LOW-level output current	$V_{O} = 0.4 V$	5 V	0.52	-	0.44	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.3	-	1.1	-	0.9	-	mA
		V <sub>O</sub> = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mA
l	input leakage current	$V_{DD} = 15 V$	15 V	-	±0.3	-	±0.3	-	±1.0	μA
I <sub>DD</sub>	supply current	I <sub>O</sub> = 0 A;	5 V	-	20	-	20	-	150	μA
		$V_{I} = V_{SS} \text{ or } V_{DD}$	10 V	-	40	-	40	-	300	μA
			15 V	-	80	-	80	-	600	μA
Cı	input capacitance		-	-	-	-	7.5	-	-	pF

### **11. Dynamic characteristics**

#### Table 7. Dynamic characteristics

 $V_{SS} = 0$  V;  $T_{amb} = 25$  °C; for test circuit see <u>Figure 5</u>; unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	Extrapolation formula	Min	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW	$nAn \rightarrow nYn;$	5 V	[1] 88 ns + (0.55 ns/pF)C <sub>L</sub>	-	115	230	ns
	propagation delay	see <u>Figure 4</u>	10 V	34 ns + (0.23 ns/pF)C <sub>L</sub>	-	45	90	ns
			15 V	22 ns + (0.16 ns/pF)C <sub>L</sub>	-	30	65	ns
		$n\overline{E} \rightarrow nYn$	5 V	98 ns + (0.55 ns/pF)C <sub>L</sub>	-	125	250	ns
			10 V	39 ns + (0.23 ns/pF)C <sub>L</sub>	-	50	95	ns
			15 V	22 ns + (0.16 ns/pF C <sub>L</sub>	-	30	65	ns
t <sub>PLH</sub>	PLH LOW to HIGH		5 V	<sup>[1]</sup> 113 ns + (0.55 ns/pF)C <sub>L</sub>	-	140	280	ns
	propagation delay		10 V	44 ns + (0.23 ns/pF)C <sub>L</sub>	-	55	105	ns
			15 V	32 ns + (0.16 ns/pF)C <sub>L</sub>	-	40	75	ns
			5 V	123 ns + (0.55 ns/pF)C <sub>L</sub>	-	150	295	ns
			10 V	44 ns + (0.23 ns/pF)C <sub>L</sub>	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C <sub>L</sub>	-	40	75	ns
t <sub>t</sub>	t transition time		5 V	[1][2] 10 ns + (1.00 ns/pF)C <sub>L</sub>	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C <sub>L</sub>	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C <sub>L</sub>	-	20	40	ns

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C<sub>L</sub> in pF).

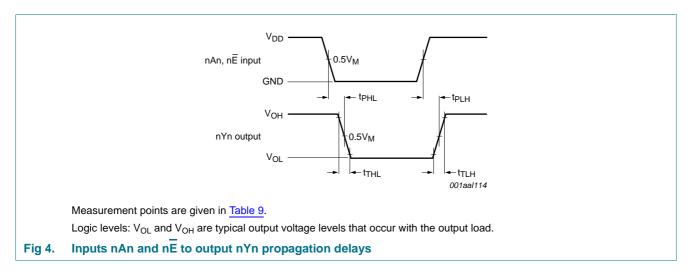
[2] Transition time tt is the same as the HIGH to LOW and LOW to HIGH transition times tTHL and tTLH.

#### Table 8. Dynamic power dissipation P<sub>D</sub>

 $P_D$  can be calculated from the formulas shown.  $V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

Symbol	Parameter	$V_{DD}$	Typical formula for $P_D$ ( $\mu W$ )	Where:
PD			$P_D = 4500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f <sub>i</sub> = input frequency in MHz,
dissipation	10 V	$P_D = 18800 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	$f_o = output frequency in MHz,$	
		15 V	$P_D = 45700 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$C_L$ = output load capacitance in pF,
				$V_{DD}$ = supply voltage in V,
				$\Sigma(f_o \times C_L)$ = sum of the outputs.

# 12. Waveforms



#### Table 9.Measurement points

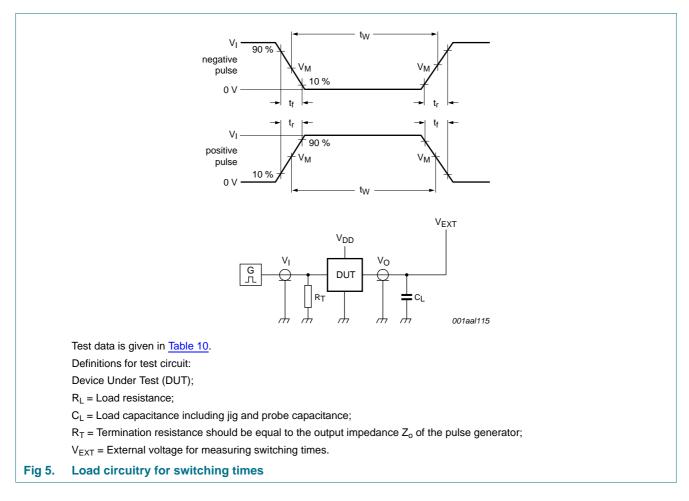
Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>

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### **NXP Semiconductors**

# **HEF4555B**

#### 1-of-4 decoder/demultiplexer

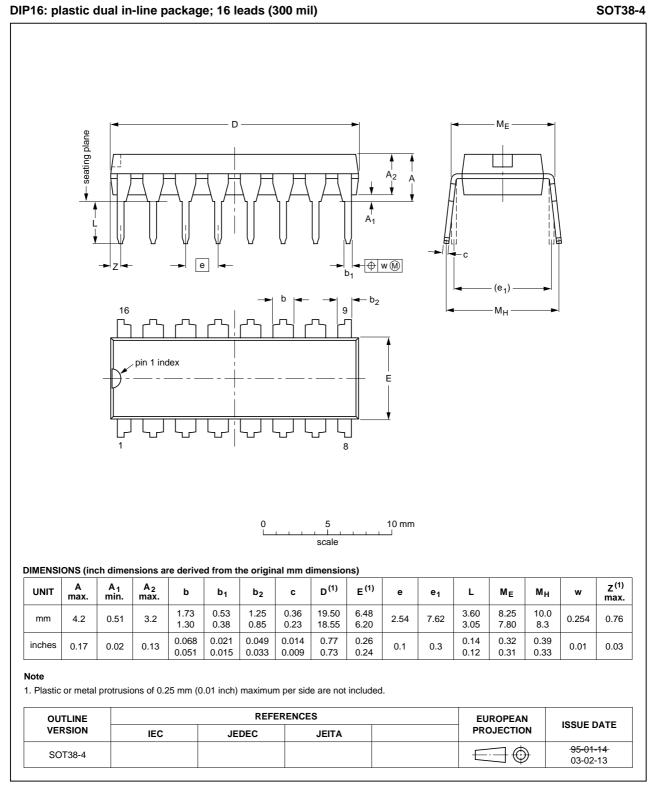


### Table 10. Test data

Supply voltage	Input		Load	V <sub>EXT</sub>	
	VI	$t_r = t_f$	CL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>THL</sub> , t <sub>TLH</sub>
5 V to 15 V	V <sub>DD</sub>	$\leq$ 20 ns	50 pF	open	V <sub>DD</sub>

1-of-4 decoder/demultiplexer

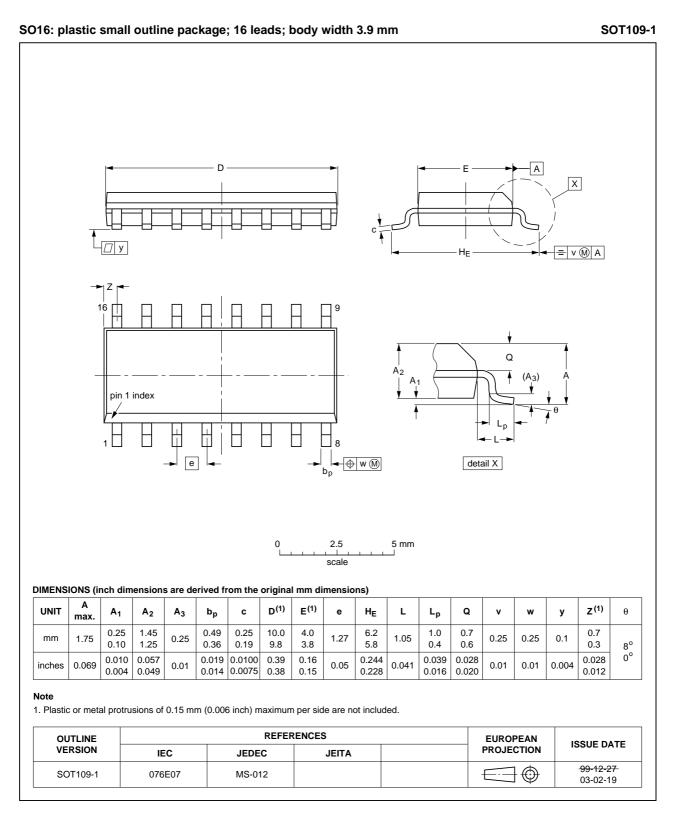
# 13. Package outline



### Fig 6. Package outline SOT38-4 (DIP16)

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1-of-4 decoder/demultiplexer



### Fig 7. Package outline SOT109-1 (SO16)

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# 14. Revision history

### Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4555B v.5	20111118	Product data sheet	-	HEF4555B v.4
Modifications:	<ul> <li><u>Table 6</u>: I<sub>OH</sub></li> </ul>	minimum values changed to	maximum	
HEF4555B v.4	20100106	Product data sheet	-	HEF4555B_CNV v.3
HEF4555B_CNV v.3	19950101	Product specification	-	HEF4555B_CNV v.2
HEF4555B_CNV v.2	19950101	Product specification	-	-

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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#### 1-of-4 decoder/demultiplexer

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